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FAN53555

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A, 2.4 MHz, Digitally Programmable TinyBuck<sup>™</sup> Regulator



# FAN53555 5 A, 2.4 MHz, Digitally Programmable TinyBuck<sup>®</sup> Regulator

#### Features

- Fixed-Frequency Operation: 2.4 MHz
- Best-in-Class Load Transient
- Continuous Output Current Capability: 5 A
- Pulse Current Capability: 6.5 A (05 Option)
- 2.5 V to 5.5 V Input Voltage Range
- Digitally Programmable Output Voltage:
  - 00/01/03/05/08/18 Options: 0.6-1.23 V in 10 mV Steps
  - 04/042/09/ Options: 0.603-1.411 V in 12.826 mV Steps
  - 23 Option: 0.60-1.3875 V in 12.5 mV Steps
  - 24 Option: 0.603-1.420 V in 12.967 mV Steps
  - 13 Option: 0.8-1.43 V in 10 mV Steps
- Programmable Slew Rate for Voltage Transitions
- I<sup>2</sup>C-Compatible Interface Up to 3.4 Mbps
- PFM Mode for High Efficiency in Light Load
- Quiescent Current in PFM Mode: 60 µA (Typical)
- Internal Soft-Start
- Input Under-Voltage Lockout (UVLO)
- Thermal Shutdown and Overload Protection
- 20-Bump Wafer-Level Chip Scale Package (WLCSP)

## Applications

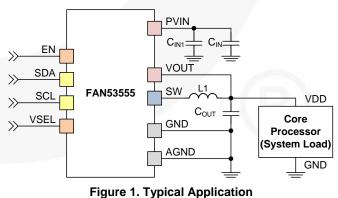
- Application, Graphic, and DSP Processors
   ARM<sup>™</sup>, Krait<sup>™</sup>, OMAP<sup>™</sup>, NovaThor<sup>™</sup>, ARMADA<sup>™</sup>
- Hard Disk Drives
- Tablets, Netbooks, Ultra-Mobile PCs
- Smart Phones
- Gaming Devices

## Description

The FAN53555 is a step-down switching voltage regulator that delivers a digitally programmable output from an input voltage supply of 2.5 V to 5.5 V. The output voltage is programmed through an I<sup>2</sup>C interface capable of operating up to 3.4 MHz.

Using a proprietary architecture with synchronous rectification, the FAN53555 is capable of delivering 5 A continuous at over 80% efficiency, while maintaining over 80% efficiency at load currents as low as 10 mA. Pulse currents as high as 6.5 A can be supported by the 05 option. The regulator operates at a nominal fixed frequency of 2.4 MHz, which reduces the value of the external components to 330 nH for the output induction and as low as 20  $\mu$ F for the output capacitor. Additional output capacitance can be added to improve regulation during load transients without affecting stability. Inductance up to 1.2  $\mu$ H may be used with additional output capacitance.

At moderate and light loads, Pulse Frequency Modulation (PFM) is used to operate in Power-Save Mode with a typical quiescent current of 60  $\mu$ A. Even with such a low quiescent current, the part exhibits excellent transient response during large load swings. At higher loads, the system automatically switches to fixed-frequency control, operating at 2.4 MHz. In Shutdown Mode, the supply current drops below 1  $\mu$ A, reducing power consumption. PFM Mode can be disabled if constant frequency is desired. The FAN53555 is available in a 20-bump, 1.6 x 2 mm, WLCSP.



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Part Number		er-Up aults	I <sup>2</sup> C Slave	A1 PIN	Max. RMS	Max. Pulse	Temperature	Package	Packing
	VSEL0	VSEL1	Address	Function	Current	Current (50 ms)	Range	- actuage	Method
FAN53555UC00X	1.05	1.20		VSEL	5 A	N/A			
FAN53555UC01X	0.90	OFF		VSEL	5 A	N/A			
FAN53555UC03X	0.90	N/A		PGOOD	5 A	N/A	-		
FAN53555UC04X	1.10	1.20	1	VSEL	5 A	N/A			
FAN53555UC05X	0.90	OFF		VSEL	5 A	6.5 A	-		
FAN53555BUC05X <sup>(1)</sup>	0.90	OFF		VSEL	5 A	6.5 A	-		
FAN53555UC08X	1.02	1.15		VSEL	4 A	N/A	-		Tape
FAN53555BUC08X <sup>(1)</sup>	1.02	1.15		VSEL	4 A	N/A			
FAN53555BUC09X <sup>(1)</sup>	1.10	1.10	C0	VSEL	3 A	N/A	10 40 05%0	WLCSP-	
FAN53555UC09X	1.10	1.10		VSEL	3 A	N/A	-40 to 85°C	20	& Reel
FAN53555UC13X	1.15	1.15		VSEL	5 A	N/A	-		
FAN53555BUC13X <sup>(1)</sup>	1.15	1.15		VSEL	5 A	N/A	-		
FAN53555UC18X	1.02	1.15		VSEL	5 A	N/A			
FAN53555BUC18X <sup>(1)</sup>	1.02	1.15	1	VSEL	5 A	N/A			
FAN53555BUC23X <sup>(1)</sup>	1.15	1.15		VSEL	5 A	N/A			
FAN53555UC24X	1.225	1.212	1	VSEL	4 A	N/A			
FAN53555BUC24X <sup>(1)</sup>	1.225	1.212	1	VSEL	4 A	N/A			
FAN53555UC042X <sup>(2)</sup>	1.10	1.20	C4	VSEL	5 A	N/A			

Notes:

1. The FAN53555BUC05X, FAN53555BUC08X, FAN53555BUC09X, FAN53555BUC13X, FAN53555BUC13X, FAN53555BUC23X, and FAN53555BUC24X, include backside lamination.

2. The 042 option is the same as the 04 option, except the I<sup>2</sup>C slave addresses.

## **Recommended External Components**

#### Table 1. Recommended External Components for 5 A Maximum Load Current

Component	Description	Vendor	Parameter	Тур.	Unit
1.4	330 nH Nominal	See Table 2	L	0.33	μH
L1	330 HE NOMINAL	See Table 2	DCR	13	mΩ
C <sub>OUT</sub>	2 Pieces; 22 μF, 6.3 V, X5R, 0805	GRM21BR60J226M (Murata) C2012X5R0J226M (TDK)	С	44	
6	1 Piece; 10 μF, 10 V, X5R, 0805	LMK212BJ106KG-T (Taiyo Yuden) C2012X5R1A106M (TDK)	С	10	μF
C <sub>IN</sub>	2 Pieces; 10 μF, 6.3 V, X5R, 0805	GRM21BR60J106M (Murata) C2012X5R0J106M (TDK)	С	20	
C <sub>IN1</sub>	10 nF, 25 V, X7R, 0402	GRM155R71E103K (Murata) C1005X7R1E103K (TDK)	С	10	nF

#### Table 2. Recommended Inductors for High-Current Applications

					Component Dimensions			
Manufacturer	Part#	L (nH)	DCR (mΩ)	I <sub>MAXDC</sub> <sup>(3)</sup>	L	w	Н	
Vishay	IHLP1616ABERR47M01	470	20.0	5.0	4.5	4.1	1.2	
Mag. Layers <sup>(4)</sup>	MMD-04ABNR33M-M1-RU	330	12.5	7.5	4.5	4.1	1.2	
Mag. Layers	MMD-04ABNR47M-M1-RU	470	20.0	5.0	4.5	4.1	1.2	
Inter-Technical	SM1608-R33M	330	9.6	9.0	4.5	4.1	2.0	
Bournes	SRP4012-R33M	330	15.0	6.7	4.7	4.2	1.2	
Bournes	SRP4012-R47M	470	20.0	5.0	4.7	4.2	1.2	
TDK	VLC5020T-R47M	470	15.0	5.4	5.0	5.0	2.0	

#### Notes:

3. I<sub>MAXDC</sub> is the lesser current to produce 40°C temperature rise or 30% inductance roll-off.

4. Preferred inductor value is 330 nH and all dynamic characterization was performed with this coil.

# FAN53555-24, -08, and -09 Reduced Output Current (4 A Max. RMS. for 08, and 24, 3 A Max. RMS for 09) Smaller Footprint Application

The FAN53555-24, -08, and -09 were developed to provide power for core processors with high-performance graphics acceleration in Li-Ion-powered handheld devices. These applications require a very compact solution. The smaller input and output capacitors in the table below assume that additional bypass capacitance exists across the battery in fairly close proximity to the regulator(s). The  $C_{IN}$  capacitors specified below are the capacitors that are required in very close proximity to VIN and PGND (see layout recommendations in Figure 2 below).

#### Table 3. Recommended External Components for Lower-Current Applications with FAN53555-08-09-24

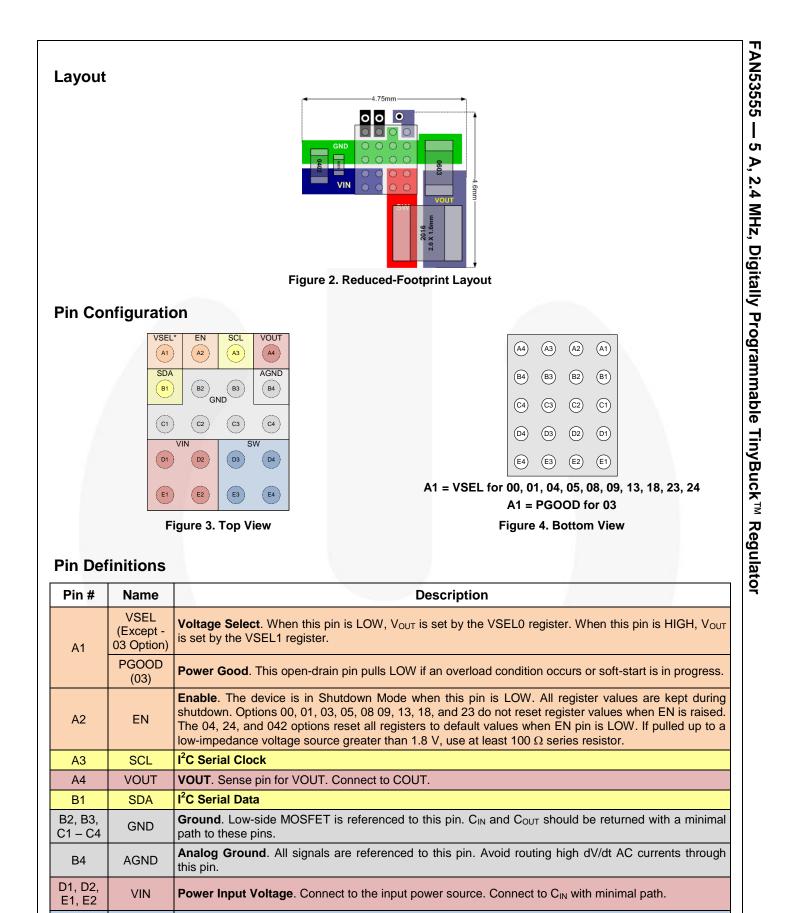
Component	Description	Vendor	Parameter	Тур.	Unit
L1	470 or 330 nH, 2016 case size	See Table			
6	-08, ,24 Option 2 Pieces 22 μF, 6.3 V, X5R, 0603		С	44	
Соит	-09 Option 1 Piece 22 μF, 6.3 V, X5R, 0603	C1608X5R0J226M (TDK)	C	22	μF
C <sub>IN</sub>	1 Piece; 10 μF, 10 V, X5R, 0402	GRM155R61A106M (Murata)	С	10	
C <sub>IN1</sub>	10 nF, 25 V, X5R, 0201	TMK063CG100DT-F (Taiyo Yuden)	С	10	nF

#### Table 4. Recommended Inductors for Lower-Current Applications with FAN53555-08-09-24

					<b>Component Dimensions</b>			
Manufacturer	Part#	L (nH)	DCR (mΩ Typ.)	I <sub>MAXDC</sub> <sup>(5)</sup>	L	w	н	
Toko	DFE201612R-H-R33N	330	25	3.2	2.0	1.6	1.2	
Toko	DFE201612C-R47N	470	40	3.2	2.0	1.6	1.2	
Cyntek	PIFE20161B-R47MS-39	470	30	3.1	2.0	1.6	1.2	
SEMCO	CIGT201610HMR47SCE	470	30	3.1	2.0	1.6	0.9	

Note:

5. I<sub>MAXDC</sub> is the lesser current to produce 40°C temperature rise or 30% inductance roll-off.



SW

D3, D4,

E3. E4

Switching Node. Connect to the inductor.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Parameter	Min.	Max.	Unit	
	Voltage on SW, VIN Pins	IC Not Switching	-0.3	7.0	v	
	Voltage on SVV, VIN FINS	IC Switching	-0.3	6.5	v	
VIN	Voltage on EN Pin	Tied without Series Resistance)	-0.3	2.0	V	
	Vollage on EN Fill	Tied through Series Resistance of at Least 100 $\Omega$	-0.3	V <sub>IN</sub> <sup>(6)</sup>		
	Voltage on All Other Pins	IC Not Switching	-0.3	V <sub>IN</sub> <sup>(6)</sup>	V	
V <sub>OUT</sub>	Voltage on VOUT Pin	on VOUT Pin		3.0	V	
VINOV_SLEW	Maximum Slew Rate of VII	N > 6.5 V, PWM Switching		100	V/ms	
ESD	Electrostatic Discharge	Human Body Model per JESD22-A114	2000		V	
ESD	Protection Level	Charged Device Model per JESD22-C101	1500		v	
TJ	Junction Temperature		-40	+150	°C	
T <sub>STG</sub>	Storage Temperature			+150	°C	
TL	Lead Soldering Temperatu	ure, 10 Seconds		+260	°C	

Note:

6. Lesser of 7 V or  $V_{IN}$ +0.3 V.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V <sub>IN</sub>	Supply Voltage Range	2.5		5.5	V
I <sub>OUT</sub>	Output Current	0	1.	5	А
L	Inductor		0.33		μH
CIN	Input Capacitor		10		μF
C <sub>OUT</sub>	Output Capacitor		44		μF
TA	Operating Ambient Temperature	-40		+85	°C
TJ	Operating Junction Temperature	-40		+125	°C

## **Thermal Properties**

Symbol	Parameter	Min.	Тур.	Max.	Unit
$\theta_{JA}$	JA Junction-to-Ambient Thermal Resistance <sup>(7)</sup>		38		°C/W

#### Note:

7. See Thermal Considerations in the Application Information section.

## **Electrical Characteristics**

Minimum and maximum values are at V<sub>IN</sub>=2.5 V to 5.5 V, T<sub>A</sub>=-40°C to +85°C, unless otherwise noted. Typical values are at T<sub>A</sub>=25°C, V<sub>IN</sub>=5 V, and EN=HIGH.

Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
Power S	Supplies						<u> </u>
		I <sub>LOAD</sub> =0			60	100	μA
Ι <sub>Q</sub>	Quiescent Current	I <sub>LOAD</sub> =0, MC	DE Bit=1 (Forced PWM)		43		mA
	H/W Shutdown Supply Current	EN=GND			0.1	5.0	μA
I <sub>SD</sub>	S/W Shutdown Supply Current	EN= V <sub>IN</sub> , BUCK_ENx=0			41	75	μA
V <sub>UVLO</sub>	Under-Voltage Lockout Threshold	V <sub>IN</sub> Rising			2.35	2.45	V
VUVHYST	Under-Voltage Lockout Hysteresis				350		m∖
EN, VSE	L, SDA, SCL					•	
VIH	HIGH-Level Input Voltage			1.1			V
VIL	LOW-Level Input Voltage					0.4	V
VLHYST	Logic Input Hysteresis Voltage				160		m٧
I <sub>IN</sub>	Input Bias Current	Input Tied t	o GND or VIN		0.01	1.00	μA
PGOOD	(03 Option)						
IOUTL	PGOOD Pull-Down Current					1	mA
Іоитн	PGOOD HIGH Leakage Current				0.01	1.00	μA
V <sub>out</sub> Reg	gulation						<u> </u>
		I <sub>OUT(DC)</sub> =0, Forced PWM, V <sub>OUT</sub> =VSEL0 Default Value		-1.5		1.5	%
		08, 24 Options	$2.5 V \le V_{IN} \le 4.5 V$ , $V_{OUT}$ from Minimum to Maximum, $I_{OUT(DC)}=0$ to 4 A, Auto PFM/PWM	-2.0		4.0	%
V <sub>REG</sub>	V <sub>OUT</sub> DC Accuracy	09 Option	$\begin{array}{l} 2.5 \ V \leq V_{\text{IN}} \leq 4.5 \ V, \\ V_{\text{OUT}} \ from \ Minimum \ to \\ Maximum, \ I_{\text{OUT}(\text{DC})}=0 \ to \\ 3 \ A, \ Auto \ PFM/PWM \end{array}$	-2.0		4.0	%
		13, 18, 23 Options	$\begin{array}{l} 2.5 \ V \leq V_{\text{IN}} \leq 4.5 \ V, \\ V_{\text{OUT}} \ from \ Minimum \ to \\ Maximum, \ I_{\text{OUT}(\text{DC})}=0 \ to \\ 5 \ A, \ Auto \ PFM/PWM \end{array}$	-2.0		4.0	%
		All Other Options	$\begin{array}{l} 2.5 \ V \leq V_{\text{IN}} \leq 5.5 \ V, \\ V_{\text{OUT}} \ from \ Minimum \ to \\ Maximum, \ I_{\text{OUT}(\text{DC})} = 0 \ to \\ 5 \ A, \ Auto \ PFM/PWM \end{array}$	-3.0		5.0	%
$\frac{\Delta V_{OUT}}{\Delta I_{LOAD}}$	Load Regulation	I <sub>OUT(DC)</sub> =1 to 5 A			-0.1	5	%//
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	2.5 V ≤ V <sub>IN</sub>	$2.5 \text{ V} \leq \text{V}_{\text{IN}} \leq 5.5 \text{ V}, \text{ I}_{\text{OUT(DC)}}=1.5 \text{ A}$		0.01		%/\
V <sub>TRSP</sub>	Transient Response		).1 A to 1.5 A, , V <sub>OUT</sub> =1.2 V		±40		m\

Continued on the following page...

## **Electrical Characteristics**

Minimum and maximum values are at V<sub>IN</sub>=2.5 V to 5.5 V, T<sub>A</sub>=-40°C to +85°C, unless otherwise noted. Typical values are at T<sub>A</sub>=25°C, V<sub>IN</sub>=5 V, and EN=HIGH.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Power S	witch and Protection		1	L		1
R <sub>DS(ON)P</sub>	P-Channel MOSFET On Resistance	V <sub>IN</sub> =5 V		28		mΩ
R <sub>DS(ON)N</sub>	N-Channel MOSFET On Resistance	V <sub>IN</sub> =5 V		17		mΩ
		00, 01, 03, 04, 13, 18, 23, 042 Options	6.3	7.4	8.5	А
ILIMPK	P-MOS Peak Current Limit	05 Option	8.5	10.0	11.5	Α
		08, 24 Options	5.0	5.9	6.8	Α
		09 Option	4.0	4.75	5.5	
T <sub>LIMIT</sub>	Thermal Shutdown			150		°C
T <sub>HYST</sub>	Thermal Shutdown Hysteresis			17		°C
		Rising Threshold		6.15		V
V <sub>SDWN</sub>	Input OVP Shutdown	Falling Threshold	5.50	5.85		V
Frequen	cy Control					
f <sub>SW</sub>	Oscillator Frequency		2.05	2.40	2.75	MHz
DAC						
	Resolution			6		Bits
	Differential Nonlinearity <sup>(8)</sup>				0.5	LSB
Timing						
I <sup>2</sup> C <sub>EN</sub>	EN=HIGH to I <sup>2</sup> C Start		100			μs
Soft-Sta	rt					
tss	Degulator Englis to Degulated V	$R_{LOAD} > 5 \Omega$ ; to V <sub>OUT</sub> =1.2 V; 00, 01, 03, 04, 042, 05, 09, 13, and 23 Options		300		μs
	Regulator Enable to Regulated V <sub>OUT</sub>	2.5 V $\leq$ V <sub>IN</sub> $\leq$ 4.5 V; R <sub>LOAD</sub> =2 $\Omega$ ; to V <sub>OUT</sub> =1.127 V with 1.1 V Pre-Bias Voltage; 08 and 18 Options		135	175	μs
R <sub>OFF</sub>	VOUT Pull-Down Resistance, Disabled	EN=0 or V <sub>IN</sub> <v<sub>UVLO</v<sub>		160	P.1	Ω

#### Note:

8. Monotonicity assured by design.

## I<sup>2</sup>C Timing Specifications

Guaranteed by design.

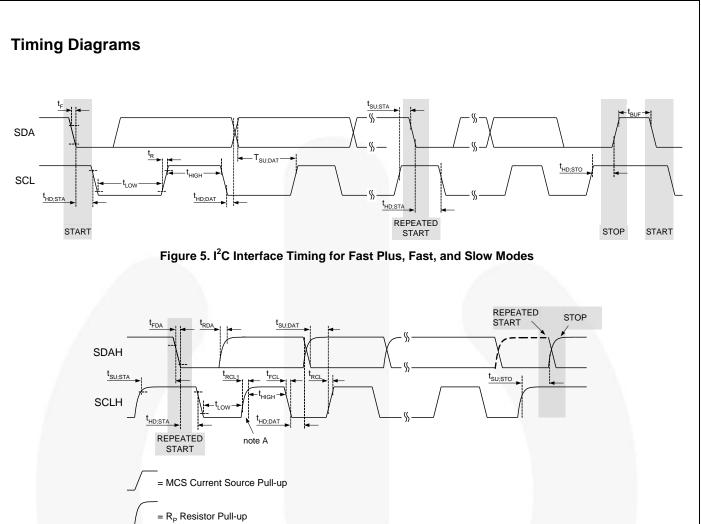
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
		Standard Mode			100		
		Fast Mode			400		
f <sub>SCL</sub>	SCL Clock Frequency	Fast Mode Plus			1000	kHz	
		High-Speed Mode, C <sub>B</sub> ≤100 pF			3400		
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF			1700		
		Standard Mode		4.7			
t <sub>BUF</sub>	Bus-Free Time between STOP and START Conditions	Fast Mode		1.3		μs	
		Fast Mode Plus		0.5			
		Standard Mode		4		μs	
	START or REPEATED START	Fast Mode		600		ns	
t <sub>HD;STA</sub>	Hold Time	Fast Mode Plus		260		ns	
		High-Speed Mode		160		ns	
		Standard Mode		4.7		μs	
		Fast Mode		1.3		μs	
t <sub>LOW</sub>	SCL LOW Period	Fast Mode Plus		0.5		μs	
		High-Speed Mode, C <sub>B</sub> ≤ 100 pF		160.0		ns	
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		320.0		ns	
		Standard Mode		4		μs	
		Fast Mode		600		ns	
t <sub>ніGH</sub>	SCL HIGH Period	Fast Mode Plus		260		ns	
		High-Speed Mode, C <sub>B</sub> ≤ 100 pF		60		ns	
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF		120		ns	
		Standard Mode		4.7		μs	
		Fast Mode		600.0		ns	
t <sub>su;sta</sub>	REPEATED START Setup Time	Fast Mode Plus		260.0		ns	
		High-Speed Mode	1	160.0		ns	
		Standard Mode		250			
		Fast Mode		100			
t <sub>SU;DAT</sub>	Data Setup Time	Fast Mode Plus		50		ns	
		High-Speed Mode		10	1		
		Standard Mode	0	1	3.45	μs	
		Fast Mode	0		900.00	ns	
t <sub>HD;DAT</sub>	Data Hold Time	Fast Mode Plus	0	1	450.00	ns	
		High-Speed Mode, C <sub>B</sub> ≤ 100 pF	0		70.00	ns	
		High-Speed Mode, C <sub>B</sub> ≤ 400 pF	0	1	150.00	ns	
		Standard Mode	20+0	.1C <sub>B</sub>	1000		
		Fast Mode		20+0.1C <sub>B</sub>			
t <sub>RCL</sub>	SCL Rise Time	Fast Mode Plus	20+0		300 120	ns	
		High-Speed Mode, C <sub>B</sub> ≤ 100 pF		10	80	113	
		High-Speed Mode, $C_B \le 400 \text{ pF}$		20	160		

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## I<sup>2</sup>C Timing Specifications (Continued)

Guaranteed by design.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
		Standard Mode	20+0.	1C <sub>B</sub>	300		
		Fast Mode	20+0.	1C <sub>B</sub>	300		
t <sub>FCL</sub>	SCL Fall Time	Fast Mode Plus	20+0.1C <sub>B</sub>		120	ns	
		High-Speed Mode, $C_B \le 100 \text{ pF}$		10	40		
		High-Speed Mode, $C_B \le 400 \text{ pF}$		20	80		
	Rise Time of SCL After a	High-Speed Mode, $C_B \le 100 \text{ pF}$		10	80		
t <sub>RCL1</sub>	REPEATED START Condition and After ACK Bit	High-Speed Mode, $C_B \le 400 \text{ pF}$		20	160	ns	
		Standard Mode	20+0.	1C <sub>B</sub>	1000		
		Fast Mode	20+0.1C <sub>B</sub>		300		
t <sub>RDA</sub>	SDA Rise Time	Fast Mode Plus	20+0.1C <sub>B</sub>		120	ns	
		High-Speed Mode, $C_B \le 100 \text{ pF}$		10	80		
		High-Speed Mode, $C_B \le 400 \text{ pF}$	20		160		
		Standard Mode	20+0.1C <sub>B</sub>		300		
		Fast Mode	20+0.	1C <sub>B</sub>	300		
t <sub>FDA</sub>	SDA Fall Time	Fast Mode Plus	20+0.	1C <sub>B</sub>	120	ns	
		High-Speed Mode, $C_B \le 100 \text{ pF}$		10	80		
		High-Speed Mode, $C_B \le 400 \text{ pF}$		20	160		
		Standard Mode		4		μs	
t	Stop Condition Sotup Time	Fast Mode		600		ns	
t <sub>su;sто</sub>	Stop Condition Setup Time	Fast Mode Plus		120		ns	
		High-Speed Mode		160		ns	
C <sub>B</sub>	Capacitive Load for SDA and SCL				400	pF	



Note A: First rising edge of SCLH after Repeated Start and after each ACK bit.

Figure 6. I<sup>2</sup>C Interface Timing for High-Speed Mode

## **Typical Characteristics**

Unless otherwise specified, Auto PFM/PWM,  $V_{IN}$  = 3.6 V,  $V_{OUT}$  = 1.2 V, SCL = SDA = VSEL = EN = 1.8 V,  $T_A$  = 25°C; circuit and components according to Figure 1 and Table 1.

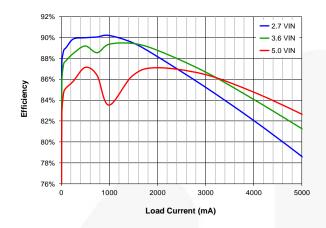


Figure 7. Efficiency vs. Load Current and Input Voltage

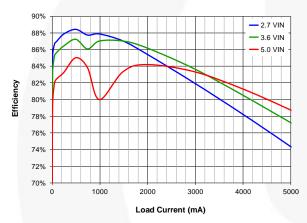


Figure 9. Efficiency vs. Load Current and Input Voltage, Vout=0.9 V

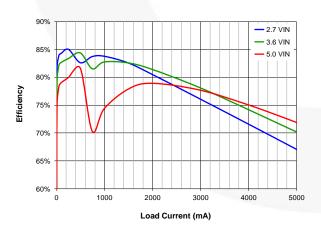


Figure 11. Efficiency vs. Load Current and Input Voltage,  $$V_{\text{OUT}}=0.6\ V$$ 

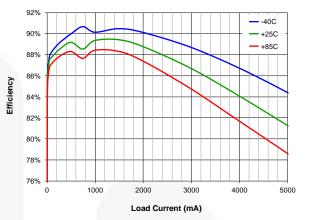


Figure 8. Efficiency vs. Load Current and Temperature

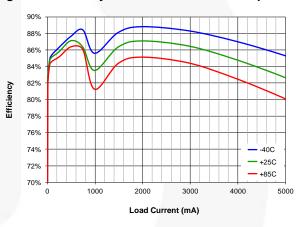


Figure 10. Efficiency vs. Load Current and Temperature,  $V_{\text{IN}}{=}5$  V,  $V_{\text{OUT}}{=}1.2$  V

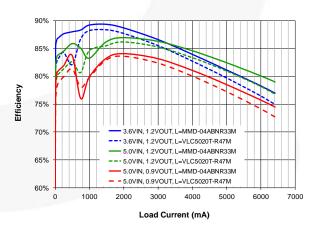


Figure 12. Efficiency vs. Load Current, V<sub>IN</sub>=3.6 V and 5 V,  $V_{OUT}$ =1.2 V and 0.9 V

## Typical Characteristics (Continued)

Unless otherwise specified, Auto PFM/PWM,  $V_{IN}$  = 3.6 V,  $V_{OUT}$  = 1.2 V, SCL = SDA = VSEL = EN = 1.8 V,  $T_A$  = 25°C; circuit and components according to Figure 1 and Table 1.



Figure 13. Output Regulation vs. Load Current and Input Voltage,  $V_{OUT}$ =1.2 V

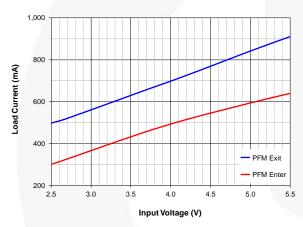
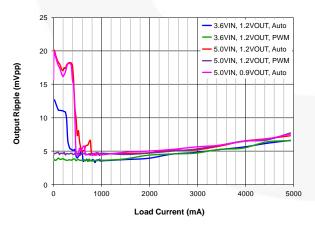
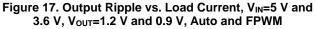


Figure 15. PFM Entry / Exit Level vs. Input Voltage, Vout=1.2 V





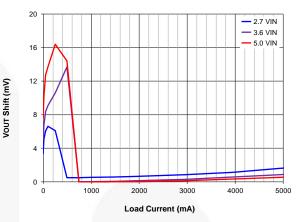


Figure 14. Output Regulation vs. Load Current and Input Voltage, Vout=0.9 V

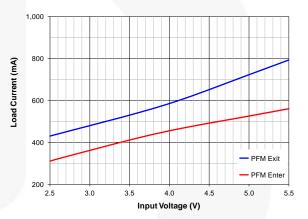
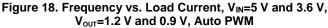


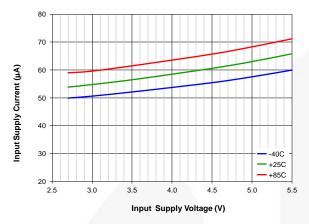
Figure 16. PFM Entry / Exit Level vs. Input Voltage, Vour=0.9 V

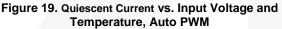




## Typical Characteristics (Continued)

Unless otherwise specified, Auto PFM/PWM,  $V_{IN}$  = 3.6 V,  $V_{OUT}$  = 1.2 V, SCL = SDA = VSEL = EN = 1.8 V,  $T_A$  = 25°C; circuit and components according to Figure 1 and Table 1.





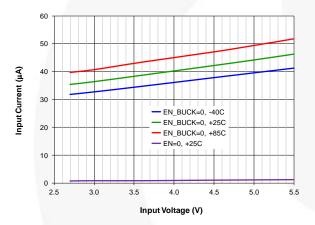


Figure 21. Shutdown Current vs. Input Voltage and Temperature



Figure 23. Line Transient, 3-4  $V_{\text{IN}},$  1.2  $V_{\text{OUT}},$  10  $\mu s$  Edge, 50  $\Omega$  Load

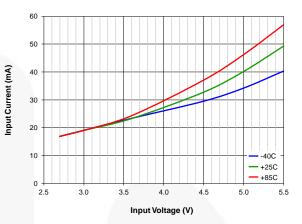


Figure 20. Quiescent Current vs. Input Voltage and Temperature, FPWM

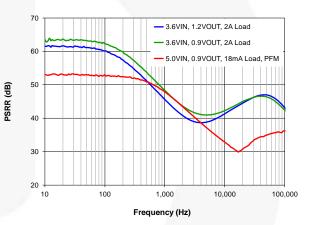


Figure 22. PSRR vs. Frequency

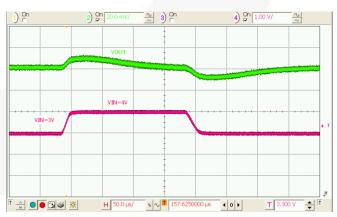
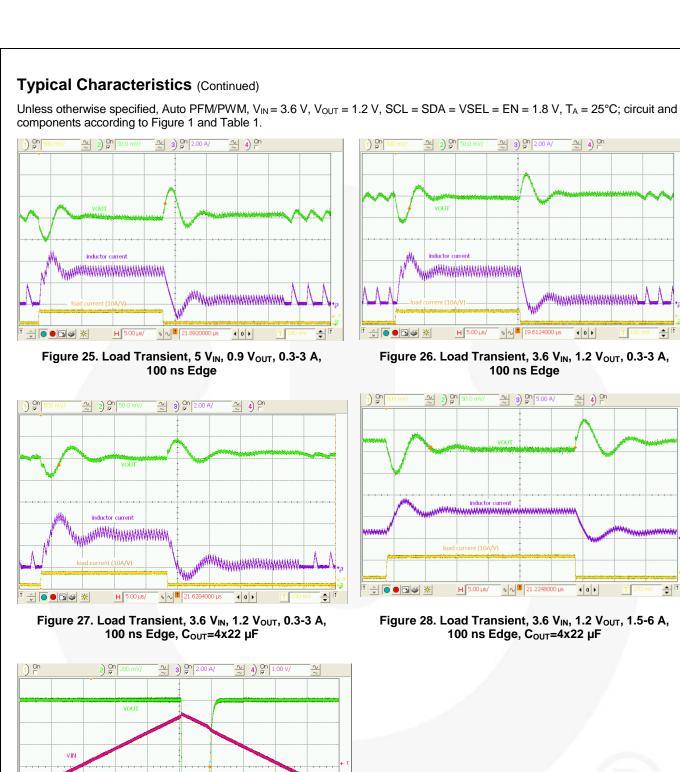


Figure 24. Line Transient, 3-4  $V_{IN},$  1.2  $V_{OUT},$  10  $\mu s$  Edge, 1 A Load

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÷ 1



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H 1.00 ms/ 1 2.7661250000 ms 4 0 >

Figure 29. Input Over-Voltage Protection

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H 5.00 µs/

inductor current

H 5.00 µs/

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~ 3) P

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100 ns Edge

3) On 5.00 A

🔹 🔨 🎩 21.2248000 µs

100 ns Edge, Cout=4x22 µF

<u>∼</u> (4) On

MANANANA MANANANA MANANANA MANANA MANANA

4 0 ►

~ 4) On

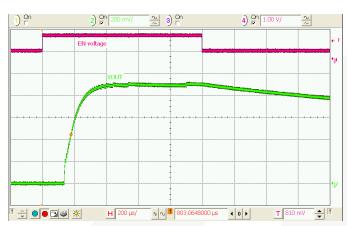
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## Typical Characteristics (Continued)

Unless otherwise specified, Auto PFM/PWM,  $V_{IN}$  = 3.6 V,  $V_{OUT}$  = 1.2 V, SCL = SDA = VSEL = EN = 1.8 V, T<sub>A</sub> = 25°C; circuit and components according to Figure 1 and Table 1.





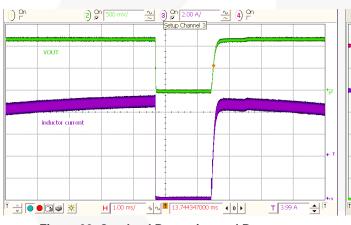


Figure 32. Overload Protection and Recovery

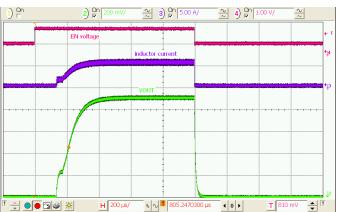


Figure 31. Startup / Shutdown, 180 mΩ Load, Vout=0.9 V

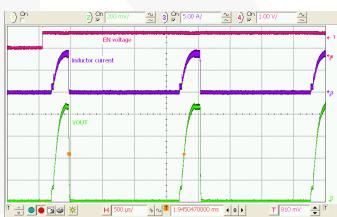


Figure 33. Startup into Faulted Load, Vour=0.9 V

## **Operation Description**

The FAN53555 is a step-down switching voltage regulator that delivers a programmable output voltage from an input voltage supply of 2.5 V to 5.5 V. Using a proprietary architecture with synchronous rectification, the FAN53555 is capable of delivering 5 A at over 80% efficiency. Pulse currents as high as 6.5 A can be supported by the 05 option. The regulator operates at a nominal frequency of 2.4 MHz at full load, which reduces the value of the external components to 330 nH for the output inductor and 22  $\mu$ F for the output capacitor. High efficiency is maintained at light load with single-pulse PFM.

The FAN53555 integrates an  $I^2$ C-compatible interface, allowing transfers up to 3.4 Mbps. This communication interface can be used to:

- Dynamically re-program the output voltage in 10 mV, 12.826 mV increments (option 04, 09, and 042), 12.5 mV increments (option 23), or 12.967 mV increments (option 24);
- Reprogram the mode to enable or disable PFM;
- Control voltage transition slew rate; or
- Enable / disable the regulator.

#### **Control Scheme**

The FAN53555 uses a proprietary non-linear, fixed-frequency PWM modulator to deliver a fast load transient response, while maintaining a constant switching frequency over a wide range of operating conditions. The regulator performance is independent of the output capacitor ESR, allowing for the use of ceramic output capacitors. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency loop holds the switching frequency constant over a large range of input voltages and load currents.

For very light loads, the FAN53555 operates in Discontinuous Current Diode (DCM) single-pulse PFM, which produces low output ripple compared with other PFM architectures. Transition between PWM and PFM is relatively seamless, providing a smooth transition between DCM and CCM Modes.

PFM can be disabled by programming the MODE bit HIGH in the VSEL registers.

#### **Enable and Soft-Start**

When the EN pin is LOW; the IC is shut down, all internal circuits are off, and the part draws very little current. In this state,  $I^2C$  cannot be written to or read from. For all options except the 04, 24, and 042 options, all register values are kept while EN pin is LOW. For the 04, 24 and 042 options; registers are reset to default values when EN pin is LOW. For all options, registers are reset to default values during a Power On Reset (POR).

When the OUTPUT\_DISCHARGE bit in the CONTROL register is enabled (logic HIGH) and the EN pin is LOW or the BUCK\_ENx bit is LOW, a load is connected from VOUT to GND to discharge the output capacitors.

Raising EN while the BUCK\_ENx bit is HIGH activates the part and begins the soft-start cycle. During soft-start, the modulator's internal reference is ramped slowly to minimize surge currents on the input and prevent overshoot of the

output voltage. Synchronous rectification is inhibited during soft-start, allowing the IC to start into a pre-charged capacitive load.

If large output capacitance values are used, the regulator may fail to start. Maximum  $C_{\text{OUT}}$  capacitance for successfully starting with a heavy constant-current load is approximately:

$$C_{\text{OUTMAX}} \approx \left( I_{\text{LIMPK}} - I_{\text{LOAD}} \right) \bullet \frac{320\,\mu}{V_{\text{OUT}}}$$
(1)

where  $C_{OUTMAX}$  is expressed in  $\mu$ F and  $I_{LOAD}$  is the load current during soft-start, expressed in A.

If the regulator is at its current limit for 16 consecutive current limit cycles, the regulator shuts down and enters 3-state before reattempting soft-start 1700 ms later. This limits the duty cycle of full output current during soft-start to prevent excessive heating.

The IC allows for software enable of the regulator, when EN is HIGH, through the BUCK\_EN bits. BUCK\_EN0 and BUCK\_EN1 are both initialized HIGH in the 00, 04, 08, 09, 23, 24, and 042 options. These options start after a POR regardless of the state of the VSEL pin.

In the 01 and 05 options, BUCK\_EN0 and BUCK\_EN1 are initialized to 10. Using these options, VSEL must be LOW after a POR if the IC is powering the processor used to communicate through  $I^2$ C. The 03 option has the VSEL input to the modulator logic internally tied LOW.

#### Table 5. Hardware and Software Enable

F	Pins	Bľ	BITS		
EN	VSEL	BUCK_EN0	BUCK_EN1	Output	
0	Х	Х	Х	OFF	
1	0	0	Х	OFF	
1	0	1	Х	ON	
1	1	Х	0	OFF	
1	1	Х	1	ON	

### VSEL Pin and I<sup>2</sup>C Programming Output Voltage

The output voltage is set by the NSELx control bits in VSEL0 and VSEL1 registers. The output voltage for options 00, 01, 03, 05, 08, and 18 is given as:

$$V_{OUT} = 0.60V + NSELx \bullet 10mV$$
 (2)

For example, when NSEL = 011111 (31 decimal), then  $V_{\text{OUT}}$  = 0.60 + 0.310 = 0.91 V.

For the 04, 042, and 09 options; the output voltage is given as:

$$V_{OUT} = 0.603 V + NSELx \bullet 12.826 mV$$
 (3)

For the 13 option, the output voltage is given as:

$$V_{OUT} = 0.80V + NSELx \bullet 10mV$$
 (4)

For the 23 option, the output voltage is given as:

$$V_{OUT} = 0.60V + NSELx \bullet 12.5mV$$
(5)

For the 24 option, the output voltage is given as:

$$V_{OUT} = 0.603V + NSELx \times 12.967 \, mV$$
 (6)

Output voltage can also be controlled by toggling the VSEL pin LOW or HIGH. VSEL LOW corresponds to VSEL0 and VSEL HIGH corresponds to VSEL1. Upon POR, VSEL0 and VSEL1 are reset to their default voltages, shown in Table 9.

#### **Transition Slew Rate Limiting**

When transitioning from a low to high voltage, the IC can be programmed for one of eight possible slew rates using the SLEW bits in the CONTROL register.

#### Table 6. Transition Slew Rate

Decimal	Bin	Slew	Rate	
0	000	64.00	mV / μs	
1	001	32.00	mV / μs	
2	2 010		mV / μs	
3	3 011		mV / µs	
4	4 100		mV / μs	
5	101	2.00	mV / μs	
6	6 110		mV / μs	
7	7 111		mV / µs	

Transitions from high to low voltage rely on the output load to discharge  $V_{\text{OUT}}$  to the new set point. Once the high-to-low transition begins, the IC stops switching until  $V_{\text{OUT}}$  has reached the new set point.

For options 04, 042, 09, 23, and 24 where the Dynamic Voltage Scaling (DVS) step is not 10 mV; the actual slew rate is the corresponding number shown in Table 6 scaled by the ratio of the DVS step to 10 mV. For example, the slew rate of option 13 for Bin=011 is 8.00 mV /  $\mu$ s X 12.5 mV / 10 mV = 10.00 mV /  $\mu$ s.

#### **Under-Voltage Lockout**

When EN is HIGH, the under-voltage lockout keeps the part from operating until the input supply voltage rises HIGH enough to properly operate. This ensures proper operation of the regulator during startup or shutdown.

#### Input Over-Voltage Protection (OVP)

When  $V_{IN}$  exceeds  $V_{SDWN}$  (about 6.2 V) the IC stops switching to protect the circuitry from internal spikes above 6.5 V. An internal filter prevents the circuit from shutting down due to noise spikes.

#### Power Good (03 Option)

The PGOOD pin is an open-drain output indicating that the regulator is enabled when its state is HIGH. PGOOD pulls LOW under the following conditions:

- Regulator is disabled (EN pin LOW, disabled by I<sup>2</sup>C, fault time-out, UVLO, OVP, over-temperature);
- Regulator is performing a soft-start.

PGOOD remains HIGH during I<sup>2</sup>C initiated V<sub>OUT</sub> transitions.

#### **Current Limiting**

A heavy load or short circuit on the output causes the current in the inductor to increase until a maximum current threshold is reached in the high-side switch. Upon reaching this point, the high-side switch turns off, preventing high currents from causing damage. Sixteen consecutive current limit cycles in current limit cause the regulator to shut down and stay off for about 1700  $\mu$ s before attempting a restart.

#### **Thermal Shutdown**

When the die temperature increases, due to a high load condition and/or high ambient temperature, the output switching is disabled until the die temperature falls sufficiently. The junction temperature at which the thermal shutdown activates is nominally 150°C with a 17°C hysteresis.

#### Monitor Register (Reg05)

The Monitor register indicates of the regulation state of the IC. If the IC is enabled and is regulating, its value is (1000 0000).

#### I<sup>2</sup>C Interface

The FAN53555's serial interface is compatible with Standard, Fast, Fast Plus, and HS Mode I<sup>2</sup>C-Bus® specifications. The FAN53555's SCL line is an input and its SDA line is a bidirectional open-drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and when signaling ACK. All data is shifted in MSB (bit 7) first.

#### I<sup>2</sup>C Slave Address

In hex notation, the slave address assumes a 0 LS Bit. The hex slave address is C0 for all options except -42, which has a hex slave address of C4.

#### Table 7. I<sup>2</sup>C Slave Address

Option	Hex					Bits			
Option	IICA	7	6	5	4	3	2	1	0
00 to 24	C0	1	1	0	0	0	0	0	R/W
42	C4	1	1	0	0	0	1	0	R/W

Other slave addresses can be assigned. Contact a Fairchild Semiconductor representative.

#### **Bus Timing**

As shown in Figure 34, data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

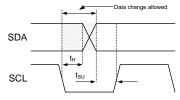


Figure 34. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in Figure 35.

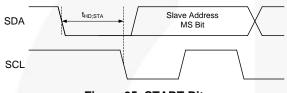
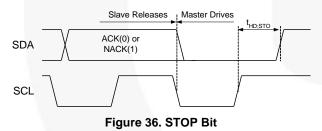
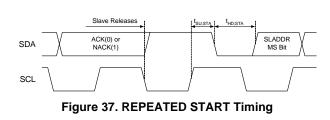


Figure 35. START Bit

A transaction ends with a STOP condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, as shown in Figure 36.



During a read from the FAN53555, the master issues a REPEATED START after sending the register address, and before resending the slave address. The REPEATED START is a 1 to 0 transition on SDA while SCL is HIGH, as shown in Figure 37.



## High-Speed (HS) Mode

The protocols for High-Speed (HS), Low-Speed (LS), and Fast-Speed (FS) Modes are identical, except the bus speed for HS mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a START condition. The master code is sent in Fast or Fast-Plus Mode (less than 1 MHz clock); slaves do not ACK this transmission.

The master generates a REPEATED START condition (Figure 35) that causes all slaves on the bus to switch to HS Mode. The master then sends  $I^2C$  packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a STOP bit (Figure 36) is sent by the master. While in HS Mode, packets are separated by REPEATED START conditions (Figure 37).

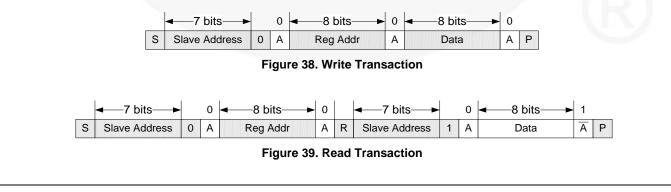
#### **Read and Write Transactions**

The following figures outline the sequences for data read and write. Bus control is signified by the shading of the packet,

defined as	Master Drives Bus	and	Slave Drives Bus	
dominoù do	s and data are MSB f	ana		••

#### Table 8. I<sup>2</sup>C Bit Definitions for Figure 38 & Figure 39

Symbol	Definition
R	REPEATED START, see Figure 37
Р	STOP, see Figure 36
S	START, see Figure 35
А	ACK. The slave drives SDA to 0 to acknowledge the preceding packet.
Ā	NACK. The slave sends a 1 to NACK the preceding packet.
R	REPEATED START, see Figure 37.
Р	STOP, see Figure 36.



## **Register Description**

## Table 9. Register Map

Hex	Nome	Function	POR Default				
Address	Name	Function	Option	V <sub>OUT</sub>	Binary	Hex	
			00	1.050	10101101	AD	
			08, 18	1.020	10101010	AA	
			01, 03, 05	0.900	10011110	9E	
			04,	1.100	10100111	A7	
00	VSEL0	Controls $V_{OUT}$ settings when VSEL pin = 0	24	1.225	10110000	B0	
			13	1.150	10100011	A3	
			23	1.150	10101100	AC	
			09	1.100	10100111	A7	
		Controls $V_{OUT}$ settings when VSEL pin = 1	00	1.200	11111100	FC	
01	VSEL1		01, 05	1.000	01101000	68	
			04,	1.200	11101111	EF	
			24	1.212	10101111	AF	
			08, 18	1.150	10110111	B7	
			13	1.150	10100011	A3	
			23	1.150	10101100	AC	
			09	1.100	11100111	E7	
		Determines whether V <sub>OUT</sub> output discharge is	00, 01, 03, 04, 05, 24		1000000	80	
02	CONTROL	enabled and also the slew rate of positive transitions	08, 09, 18		0000000	00	
			13, 23		10110000	B0	
			00, 13, 23, 24		10000000	80	
			01		10000001	81	
			03		10000011	83	
03	ID1	Read-only register identifies vendor and chip type	04		10000100	84	
			05		10000101	85	
			08, 18		10001000	88	
			09		10001100	8C	
04	ID2	Read-only register identifies die revision	All		0000XXXX	0X	
05	MONITOR	Indicates device status	All		X0000000	X0	

FAN53555 — 5 A, 2.4 MHz, Digitally Programmable TinyBuck<sup>™</sup> Regulator

## **Bit Definitions**

The following table defines the operation of each register bit. Bold indicates power-on default values.

Bit	Name	Value	Description
VSEL	_0 R/W	Register Addre	ess: 00
7	BUCK_EN0	1	Software buck enable. When EN pin is LOW, the regulator is off. When EN pin is HIGH, BUCK_EN bit takes precedent.
6	MODE0	0	Allow Auto-PFM Mode during light load.
0	NODEO	1	Forced PWM Mode.
		00 Option <b>101101</b>	
		08, 18 Options <b>101010</b>	Sets V <sub>OUT</sub> value from 0.6 to 1.23 V in 10 mV steps (see Eq. (2)).
		01, 03, 05 Options 011110	
5.0		04 Option 100111	
5:0	NSEL0	09 Option <b>100111</b>	Sets V <sub>OUT</sub> value from 0.603 to 1.411 V in 12.826 mV steps (see Eq. (3)).
		13 Option <b>100011</b>	Sets V <sub>OUT</sub> value from 0.8 to 1.43 V in 10 mV steps (see Eq. (4)).
		23 Option 101100	Sets V <sub>OUT</sub> value from 0.6 to 1.3875 V in 12.5 mV steps <i>(see Eq. (5)).</i>
		24 Option 110000	Sets V <sub>OUT</sub> value from 0.603 to 1.42 V in 12.967 mV steps <i>(see Eq. (6)).</i>
VSEL	_1 R/W	Register Addre	ess: 01
7	BUCK_EN1	00, 04, 08, 09,13, 18, 23, 24 Options <b>1</b> 01, 05 Options	Software buck enable. When EN pin is LOW, the regulator is off. When EN pin is HIGH, BUCK_EN bit takes precedent.
		0	
0	MODEA	08, 13, 18, 23, 24 Options <b>0</b>	Allow AUTO-PFM Mode during light load.
6	MODE1	00, 01, 04, 05, 09 Options <b>1</b>	Forced PWM Mode.
		00 Option 111100	
		01, 05 Options <b>101000</b>	Sets V <sub>OUT</sub> value from 0.6 to 1.23 V in 10 mV steps <i>(see Eq. (2)).</i>
		08, 18 Options <b>110111</b>	
5:0	NSEL1	04 Option <b>101111</b>	Sets V <sub>our</sub> value from 0.603 to 1.411 V in 12.826 mV steps <i>(see Eq. (3)).</i>
5.0	NJELI	09 Option 100111	Sets VOUL Value HULL 0.003 to 1.411 V III 12.020 HIV Steps (See Eq. (3)).
		13 Option 100011	Sets V <sub>OUT</sub> value from 0.8 to 1.43 V in 10 mV steps (see Eq. (4)).
		23 Option 101100	Sets V <sub>OUT</sub> value from 0.6 to 1.3875 V in 12.5 mV steps (see Eq. (5)).
		24 Option 101111	Sets V <sub>OUT</sub> value from 0.603 to 1.42 V in 12.967 mV steps (see Eq. (6)).

FAN53555 I S Ś , 2.4 MHz, Digitally Programmable TinyBuck™ Regulator

## **Bit Definitions**

The following table defines the operation of each register bit. Bold indicates power-on default values.

Bit	Name	Value	Description
CON	ITROL R/W	Register Addre	ess: 02
		08, 09, 18 Options <b>0</b>	When the regulator is disabled, V <sub>OUT</sub> is not discharged.
7	OUTPUT_DISCHARGE	00, 01, 03, 04, 05,13, 23, 24 Options <b>1</b>	When the regulator is disabled, $V_{\text{OUT}}$ discharges through an internal pull-down.
6:4	SLEW	<b>000</b> –111	Sets the slew rate for positive voltage transitions (see Table 6).
		011	Default value for 13 and 23 options
3	Reserved	0	Always reads back 0
2	04, 09, 24 Options RESET	0	Setting to 1 resets all registers to default values.
2	All other options Reserved	0	Always reads back 0
1:0	Reserved	00	Always reads back 00
ID1	R	Register Addre	ess: 03
7:5	VENDOR	100	Signifies Fairchild as the IC vendor
4	Reserved	0	Always reads back 0
		0000	IC Type = 00 Option (FAN53555UC00X / FAN53555BUC24X)
		0001	IC Type = 01 Option (FAN53555UC01X)
		0011	IC Type = 03 Option (FAN53555UC03X)
		0100	IC Type = 04 Option (FAN53555UC04X)
		0100	IC Type = 042 Option (FAN53555UC042X)
3:0	DIE_ID	0101	IC Type = 05 Option (FAN53555UC05X / FAN53555BUC05X)
		1000	IC Type = 08, 18 Options (FAN53555UC08X / FAN53555BUC08X, FAN53555UC18X / FAN53555BUC18X)
		1100	IC Type = 09 Option (FAN53555UC09X / FAN53555BUC09X)
		0000	IC Type = 13 Option (FAN53555UC13X / FAN53555BUC13X)
		0000	IC Type = 23 Option (FAN53555BUC23X)
ID2	R	Register Addre	ess: 04
7:4	Reserved	0000	Always reads back 0000
		00 Option <b>0011</b>	
		01 Option 0011	
		03 Option 0011	
		04 Option 1111	
3:0	DIE_REV	24-Option <b>0100</b>	IC mask revision
		042 Option 1111	
		05 Option <b>0011</b>	
		08, 18 Options <b>0001</b>	

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## **Bit Definitions**

The following table defines the operation of each register bit. Bold indicates power-on default values.

Bit	Name	Value	Description
		BUC08, BUC18 Options	
		1111	
		09 Option	
		1111	
		13 Option	
		1111	
		23 Option	
		1100	
MON	NITOR R	Register Addr	ess: 05
7	PGOOD	0	1: buck is enabled and soft-start is completed
6:0	Not used	000 0000	Always reads back 000 0000

## **Application Information**

#### Selecting the Inductor

The output inductor must meet both the required inductance and the energy-handling capability of the application. The inductor value affects the average current limit, the output voltage ripple, and the efficiency.

The ripple current ( $\Delta I$ ) of the regulator is:

$$\Delta I \approx \frac{V_{OUT}}{V_{N}} \bullet \left(\frac{V_{N} - V_{OUT}}{L \bullet f_{SW}}\right)$$
(7)

The maximum average load current,  $I_{MAX(LOAD)}$ , is related to the peak current limit,  $I_{LIM(PK)}$ , by the ripple current such that:

$$I_{MAX(LOAD)} = I_{LIM(PK)} - \frac{\Delta I}{2}$$
(8)

The FAN53555 is optimized for operation with L=330 nH, but is stable with inductances up to 1.0  $\mu H$  (nominal). The inductor should be rated to maintain at least 80% of its value at I<sub>LIM(PK)</sub>. Failure to do so lowers the amount of DC current the IC can deliver.

Efficiency is affected by the inductor DCR and inductance value. Decreasing the inductor value for a given physical size typically decreases the DCR; but since  $\Delta I$  increases, the RMS current increases, as do core and skin-effect losses.

$$I_{\rm RMS} = \sqrt{I_{\rm OUT(DC)}^2 + \frac{\Delta I^2}{12}}$$
(9)

The increased RMS current produces higher losses through the  $R_{DS(ON)}$  of the IC MOSFETs as well as the inductor ESR.

Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

## Table 10. Effects of Inductor Value (from 330 nH Recommended) on Regulator Performance

I <sub>MAX(LOAD)</sub>	$\Delta V_{OUT}^{(Eq.(11))}$	Transient Response
Increase	Decrease	Degraded

#### **Inductor Current Rating**

The current limit circuit can allow substantial peak currents to flow through L1 under worst-case conditions. If it is possible for the load to draw such currents, the inductor should be capable of sustaining the current or failing in a safe manner.

For space-constrained applications, a lower current rating for L1 can be used. The FAN53555 may still protect these inductors in the event of a short circuit, but may not be able to protect the inductor from failure if the load is able to draw higher currents than the DC rating of the inductor.

#### Output Capacitor and VOUT Ripple

Table 1 suggests 0805 capacitors, but 0603 capacitors may be used if space is at a premium. Due to voltage effects, the 0603 capacitors have a lower in-circuit capacitance than the 0805 package, which can degrade transient response and output ripple. Increasing  $C_{OUT}$  has negligible effect on loop stability and can be increased to reduce output voltage ripple or to improve transient response. Output voltage ripple,  $\Delta V_{OUT}$ , is calculated by:

$$\Delta V_{OUT} = \Delta I_{L} \left[ \frac{f_{SW} \cdot C_{OUT} \cdot ESR^{2}}{2 \cdot D \cdot (1 - D)} + \frac{1}{8 \cdot f_{SW} \cdot C_{OUT}} \right]$$
(10)

where  $C_{OUT}$  is the effective output capacitance.

The capacitance of  $C_{OUT}$  decreases at higher output voltages, which results in higher  $\Delta V_{OUT}$ . Equation (10) is only valid for Continuous Current Mode (CCM) operation, which occurs when the regulator is in PWM Mode.

For large  $C_{OUT}$  values, the regulator may fail to start under a load. If an inductor value greater than 1.0  $\mu$ H is used, at least 30  $\mu$ F of  $C_{OUT}$  should be used to ensure stability.

The lowest  $\Delta V_{\text{OUT}}$  is obtained when the IC is in PWM Mode and, therefore, operating at 2.4 MHz. In PFM Mode,  $f_{\text{SW}}$  is reduced, causing  $\Delta V_{\text{OUT}}$  to increase.

#### ESL Effects

The Equivalent Series Inductance (ESL) of the output capacitor network should be kept low to minimize the squarewave component of output ripple that results from the division ratio  $C_{OUT}$  ESL and the output inductor ( $L_{OUT}$ ). The squarewave component due to the ESL can be estimated as:

$$\Delta V_{OUT(SQ)} \approx V_{IN} \bullet \frac{ESL_{COUT}}{L1}$$
(11)

A good practice to minimize this ripple is to use multiple output capacitors to achieve the desired  $C_{OUT}$  value. For example, to obtain  $C_{OUT}$ =20  $\mu$ F, a single 22  $\mu$ F 0805 would produce twice the square wave ripple as two x 10  $\mu$ F 0805.

To minimize ESL, try to use capacitors with the lowest ratio of length to width. 0805s have lower ESL than 1206s. If low output ripple is a chief concern, some vendors produce 0508 or 0612 capacitors with ultra-low ESL. Placing additional small-value capacitors near the load also reduces the highfrequency ripple components.

#### **Input Capacitor**

The ceramic input capacitors should be placed as close as possible between the VIN pin and PGND to minimize the parasitic inductance. If a long wire is used to bring power to the IC, additional "bulk" capacitance (electrolytic or tantalum) should be placed between  $C_{IN}$  and the power source lead to reduce under-damped ringing that can occur between the inductance of the power source leads and  $C_{IN}$ .

The effective  $C_{\text{IN}}$  capacitance value decreases as  $V_{\text{IN}}$  increases due to DC bias effects. This has no significant impact on regulator performance.

#### **Thermal Considerations**

Heat is removed from the IC through the solder bumps to the PCB copper. The junction-to-ambient thermal resistance ( $\theta_{JA}$ ) is largely a function of the PCB layout (size, copper weight, and trace width) and the temperature rise from junction to ambient ( $\Delta T$ ).

For the FAN53555UC,  $\theta_{JA}$  is 38°C/W when mounted on its four-layer evaluation board in still air with two-ounce outer layer copper weight and one-ounce inner layers. Halving the copper thickness results in an increased  $\theta_{JA}$  of 48°C/W.

For long-term reliable operation, the IC's junction temperature  $(T_{\rm J})$  should be maintained below 125°C.

To calculate maximum operating temperature ( $\leq$ 125°C) for a specific application:

- 1. Use efficiency graphs to determine efficiency for the desired  $V_{IN}$ ,  $V_{OUT}$ , and load conditions.
- 2. Calculate total power dissipation using:

$$P_{T} = V_{OUT} \times I_{LOAD} \times \left(\frac{1}{\eta} - 1\right)$$
(12)

where  $\eta$  is efficiency from Figure 7 through Figure 12.

3. Estimate inductor copper losses using:

$$P_{L} = I_{LOAD}^{2} \times DCR_{L}$$
(13)

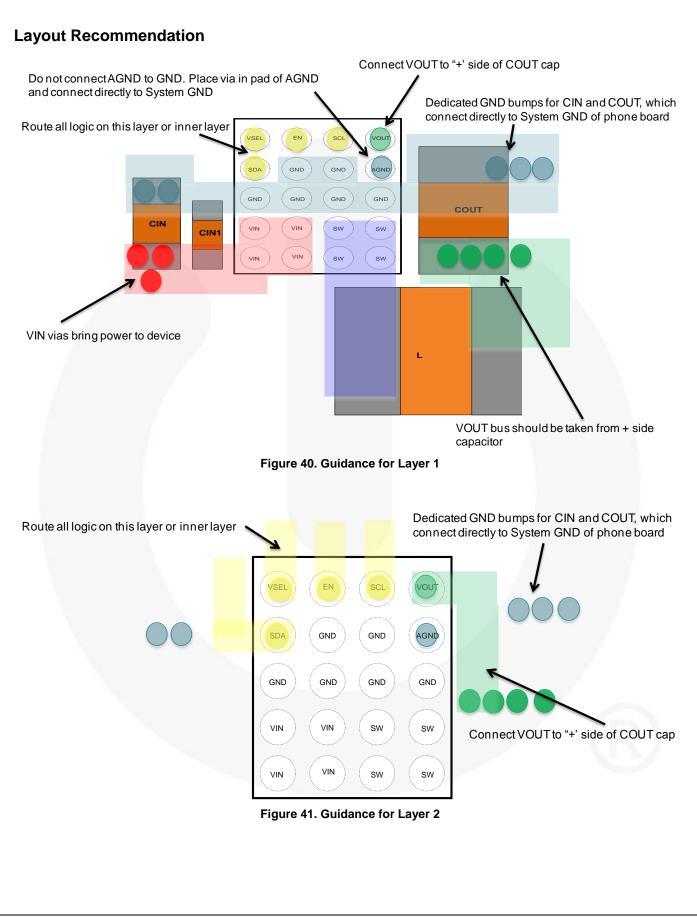
4. Determine IC losses by removing inductor losses (step 3) from total dissipation:

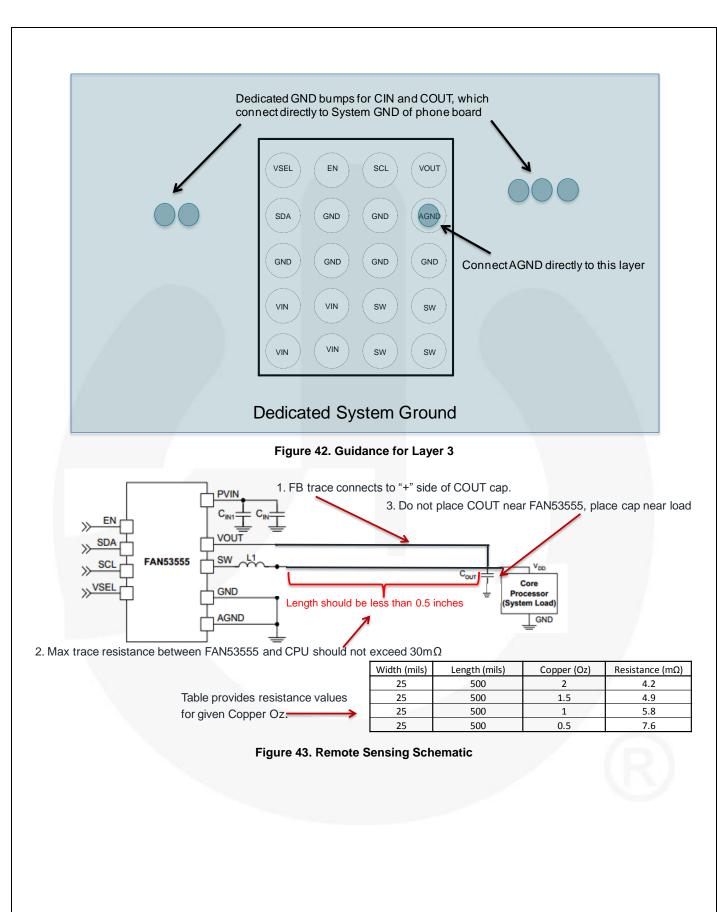
$$P_{\rm IC} = P_{\rm T} - P_{\rm L} \tag{14}$$

5. Determine device operating temperature:

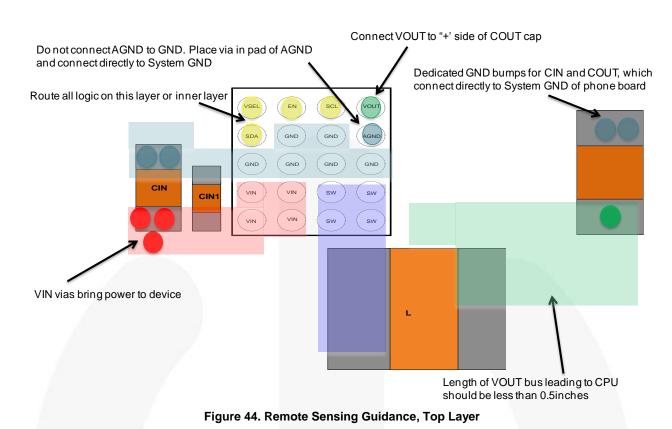
$$\Delta T = P_{IC} \times \Theta_{JA}$$
and
(15)
$$T_{IC} = T_{IC} + \Delta T$$

It is important to note that the  $R_{DS(ON)}$  of the IC's power MOSFETs increases linearly with temperature at about 1.21%/°C. This causes the efficiency ( $\eta$ ) to degrade with increasing die temperature.



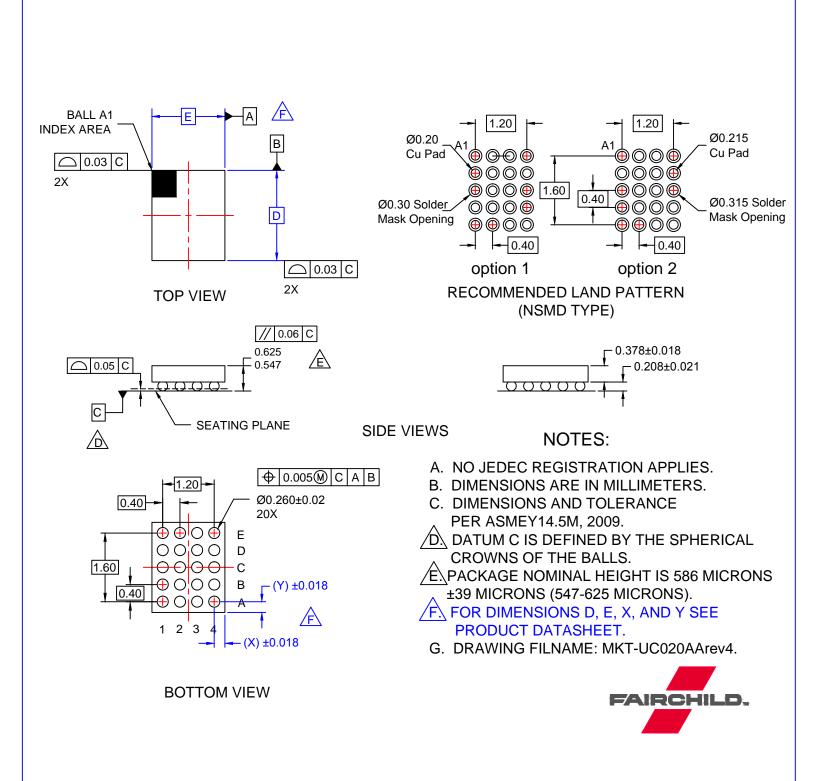






### **Product-Specific Dimensions**

Product	D	E	Х	Y	Land Pattern
FAN53555UC00 to FAN53555UC08X, FAN53555BUC05X	2.000 ±0.03	1.600 ±0.03	0.200	0.200	Option 1
FAN53555BUC08X, FAN53555BUC09X, FAN53555UC09X, FAN53555UC13X, FAN53555BUC13X, FAN53555UC18X, FAN53555BUC18X, FAN53555BUC23X, FAN53555UC24X, FAN53555BUC24X,	2.015 ±0.03	1.615 ±0.03	0.2075	0.2075	Option 2



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